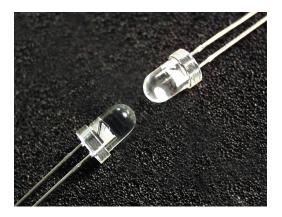


C503B-Axx-015: 5-mm Round Amber LEDs



PRODUCT DESCRIPTION

Round LEDs offer superior light output • for excellent readability in sunlight and dependable performance. They provide • extremely stable light output over long periods of time.

These lamps are made with an advanced optical-grade epoxy offering superior high-temperature and high-moisture-resistance performance in outdoor signal and sign . applications.

FEATURES

- Size (mm): 5
- Color and Typical Dominant
 Wavelength:
 Amber (591nm)
- Luminous Intensity (mcd) C503B-AAS/AAN-015: (12000-32900)
- Viewing angles: C503B-AAS/AAN-015 15 degree minimum
- Lead Free
- RoHS Compliant

APPLICATIONS

- Electronic Signs & Signals (ESS)
- Motorway Signs
- Variable Message Sign (VMS)
- Advertising Signs
- Petrol Signs
- Amusement
- Roadway Signs

Cree LED / 4400 Silicon Drive / Durham, NC 27703 USA / +1.919.313.5330 / www.cree-led.com

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ABSOLUTE MAXIMUM RATINGS (T_A = 25°C)

Items Symbol		Absolute Maximum Rating	Unit		
Forward Current	I _F	50 Note1	mA		
Peak Forward Current Note2	vard Current Note2 I _{FP} 200		mA		
Reverse Voltage	V _R	5	V		
Power Dissipation	P _D	130	mW		
Operation Temperature	T _{opr}	-40 ~ +100	°C		
Storage Temperature	T _{stg}	-40 ~ +100	°C		
Lead Soldering Temperature	T _{sol}	Max. 260°C for 3 sec. max. (3 mm from the base of the epoxy bulb)			
Electrostatic Discharge Classification (MIL-STD-883E)	ESD	Class 2			

Note:

1. For long term performance the drive currents between 10mA and 30mA are recommended. Please contact Cree LED sales representative for more information on recommended drive conditions.

2. Pulse width ≤ 0.1 msec, duty $\leq 1/10$.

TYPICAL ELECTRICAL & OPTICAL CHARACTERISTICS (T_A = 25°C)

Characteristics	Symbol	Condition	Unit	Minimum	Typical	Maximum
Forward Voltage	V _F	I _F = 20 mA	V		2.1	2.6
Reverse Current	I _R	V _R = 5 V	μA			100
Dominant Wavelength	λ_{D}	I _F = 20 mA	nm	584	591	596
Luminous Intensity	l _v	I _F = 20 mA	mcd	12000	15000	
50% Power Angle	201⁄2	I _F = 20 mA	deg	15		

* Continuous reverse voltage can cause LED damage.



INTENSITY BIN LIMIT

Amber

15° min(20 mA) - C503B-AAS/AAN-015						
Bin Code Min.(mcd) Max.(mcd)						
A0	12000	16800				
B0	16800	23500				
CO	23500	32900				

* Tolerance of measurement of luminous intensity is ±15%

COLOR BIN LIMIT

Amber (20 mA) - C503B-Axx						
Bin Code	Bin Code Min.(nm)					
A2	584	587				
A3	587	590				
A4	590	593				
A5	593	596				

* Tolerance of measurement of dominant wavelength is ±1 nm.

ORDER CODE TABLE

Viewing			Luminous Intensity (mcd)		Dominant Wavelength					
Color	Color Angle	Order Code	Min.	Max.	Color Bin	Min.(nm)	Color Bin	Max.(nm)	Package	Standoff
		C503B-AAS-CA0C0251-015	12000	32900	A2	584	A5	596	Bulk	Yes
		C503B-AAS-CA0C0341-015	12000	32900	A3	587	A4	593	Bulk	Yes
		C503B-AAN-CA0C0251-015	12000	32900	A2	584	A5	596	Bulk	No
A	15°	C503B-AAN-CA0C0341-015	12000	32900	A3	587	A4	593	Bulk	No
Amber	15	C503B-AAS-CA0C0252-015	12000	32900	A2	584	A5	596	Ammo	Yes
		C503B-AAS-CA0C0342-015	12000	32900	A3	587	A4	593	Ammo	Yes
		C503B-AAN-CA0C0252-015	12000	32900	A2	584	A5	596	Ammo	No
		C503B-AAN-CA0C0342-015	12000	32900	A3	587	A4	593	Ammo	No

Notes:

• The above kit numbers represent order codes that include multiple intensity-bin and color-bin codes. Only one intensity-bin code and one color-bin code will be shipped on each bulk. Single intensity-bin code and single color-bin codes will not be orderable.

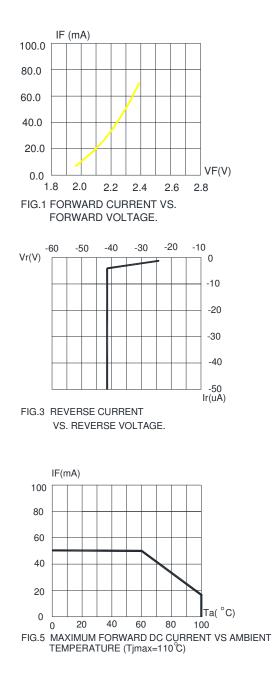
• Please refer to the HB LED Lamp Reliability Test Standards document for reliability test conditions.

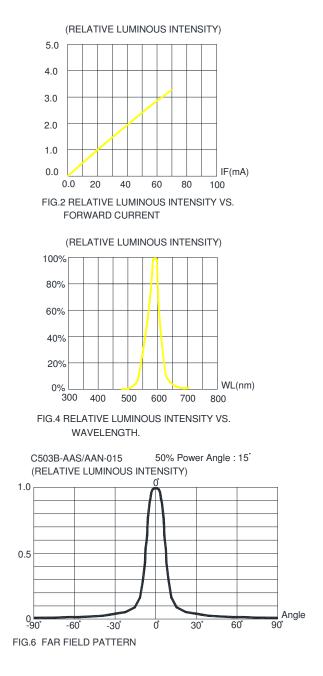
• Please refer to the HB LED Lamp Soldering & Handling document for information about how to use this LED product safely.

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GRAPHS

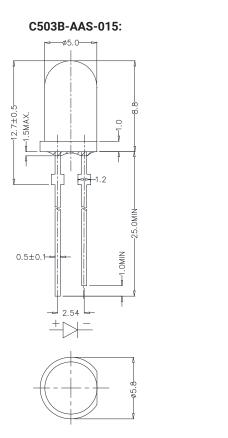
The data below are collected from statistical figures that do not necessarily correspond to the actual parameters of each single LED. Hence, these data will be changed without further notice.

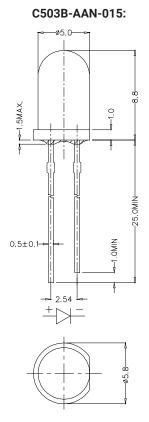




MECHANICAL DIMENSIONS

All dimensions are in mm. Tolerance is ± 0.25 mm unless otherwise noted. An epoxy meniscus may extend about 1.5 mm down the leads. Burr around bottom of epoxy may be 0.5 mm max.





NOTES

RoHS Compliance

The levels of RoHS restricted materials in this product are below the maximum concentration values (also referred to as the threshold limits) permitted for such substances, or are used in an exempted application, in accordance with EU Directive 2011/65/EC (RoHS2), as implemented January 2, 2013. RoHS Declarations for this product can be obtained from your Cree LED representative or from the Product Ecology section of the Cree LED website.

Vision Advisory

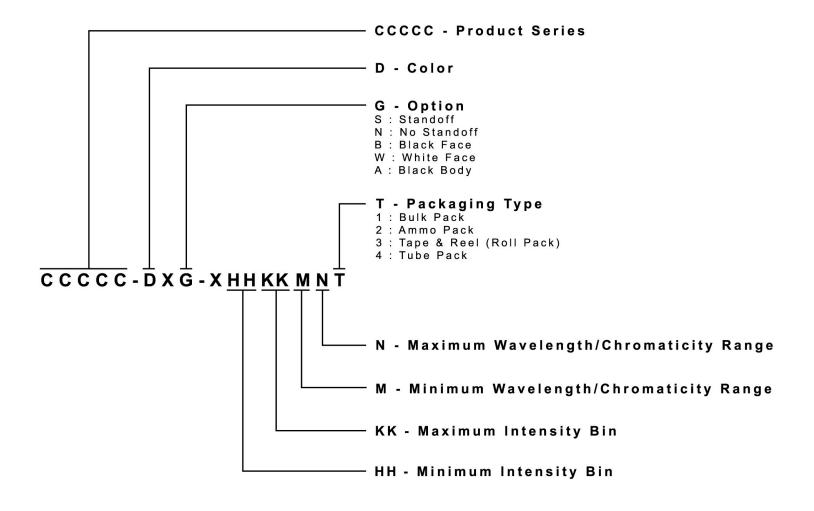
WARNING: Do not look at an exposed lamp in operation. Eye injury can result.

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KIT NUMBER SYSTEM

Cree LED lamps are tested and sorted into performance bins. A bin is specified by ranges of color, forward voltage, and brightness. Sorted LEDs are packaged for shipping in various convenient options.

Cree LEDs are sold by order codes in combinations of bins called kits. Order codes are configured in the following manner:

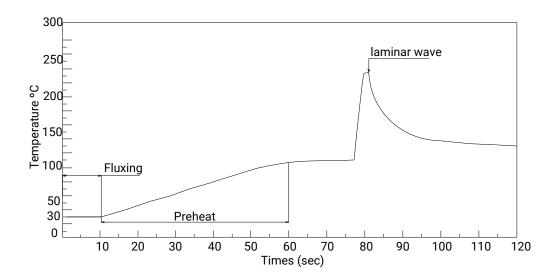


SOLDERING GUIDELINES

The LED soldering specification is shown below(suitable for both leaded solder & lead-free solder):

Manual Soldering		Solder Dipping			
Soldering iron	35 W max	Preheat	110 °C max		
Tomporatura	300 °C max	Preheat time	60 seconds max		
Temperature	300 °C max	Solder-bath temperature	260 °C Max		
Soldering time	3 seconds max	Dipping time	5 seconds max		
Position	Not less than 3 mm from the base of the package.	Position	Not less than 3 mm from the base of the package.		

- Manual soldering onto the PCB is not recommended because soldering time is uncontrollable.
- The recommended wave soldering is as below:



- Do not apply any stress to the LED package, particularly when heated.
- Only bottom preheat is suggested & should not preheat on top in order to reduce thermal stress experienced by the LEDs.
- The LEDs must not be re used once they have been extracted from PCB.
- After soldering the LEDs, the package should be protected from mechanical shock or vibration until the LEDs have reached 40 °C or below.
- Precautions must be taken as mechanical stress on the LEDs may be caused by PCB warpage or from the clinching and cutting of the LED leads.
- When it is necessary to clam the LEDs during soldering, it is important to ensure no mechanical stress is exerted on the LEDs.
- Cut the LED lead at normal room temperature. Lead cutting at high temperature may cause failure of the LEDs.
- Please refer to the HB LED Lamp Soldering & Handling document for information about how to use this LED product safely.

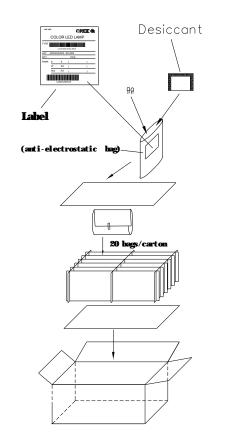


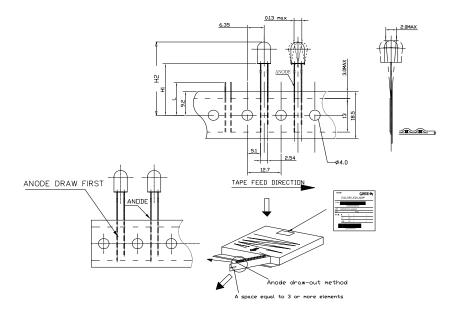
PACKAGING

- · The LEDs are packed in cardboard boxes after packaging in normal or anti-electrostatic bags.
- · Cardboard boxes will be used to protect the LEDs from mechanical shock during transportation.
- The boxes are not water resistant, and they must be kept away from water and moisture.
- Max 500 pcs per bulk and Max 2500 pcs per ammo.

Bulk Pack Packaging Type:

Ammo Pack Packaging Type:





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LTL-10234W LTL-10254W LTL-1214A LTL-2231AT LTL2H3HRKL13 LTL-3251A LTL-4262N LTL-433P LTL-5234 LTL87HTBK LTW-87HD4B 7383/V7C3-BSTA-L/PR3/MS 1254-10SDRDS530-A3 HLMP-3507-D00B1 1L0532V23G0TD001 LO566UHR3-70G-A3 LP379PPG1C0G0300001 SLR-342MC3F SLX-LX3044GD SLX-LX3044ID SLX-LX3044YD 1.90690.3330000 SSS-LX4673ID-410B 1L0532Y24I0TD001 264-7SYGD/S530-E2 HLMP1385 LTL-10224W LTL-1224A LTL-1BEHJ-012 LTL-2251AT LTL-403HR LTL-4222 LU7-E-B 4380H1 TLHY44K1L2 HLMP-3451-D0000 HLMP-EL08-XYK00 L53SRC/E-Z L-7679C1ZGC 4302T1-5V 4306D23 4363D1/5 WP1503SRC/J4 WP153GDT WP153YDT WP1543SGC WP1543SRC/D WP1543SURC WP53MGD WP7113HD